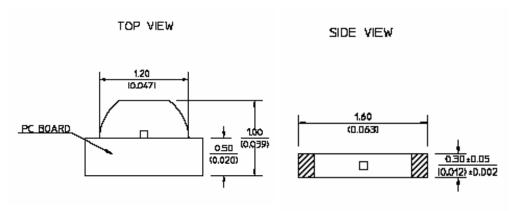
AVAGO ASMT-CW30 0.3mm Right Angle Surface Mount ChipLED InGaN White

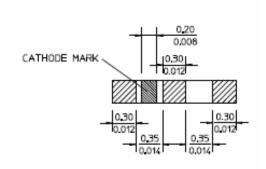


Datasheet

Package Dimension







NOTES:

- 1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
- 2. TOLERANCE IS \pm 0.1 mm (\pm 0.004 IN.) UNLESS OTHERWISE SPECIFIED.

Device Selection Guide

Package Dimension (mm)	Parts per Reel	Package Description
1.6 (L) x 1.0 (W) x 0.3 (H)	4000	Untinted, Diffused

CAUTION: ASMT-CW30 LEDs are Class 1A ESD sensitive per JESD22-A114C.01. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

For product information and a complete list of distributors, please go to our web site: www.avagotech.com



Absolute Maximum Ratings at T_A = 25°C

Parameter	ASMT-CW30	Unit	
DC Forward Current [1]	10	mA	
Power Dissipation	32	mW	
Reverse Voltage (I _R = 100μA)	5	V	
LED Junction Temperature	95	°C	
Operating Temperature Range	-40 to 85	°C	
Storage Temperature Range	-40 to 85	°C	
Soldering Temperature	See reflow soldering profile (Figure 7 & 8)		

Note:

1. Derate linearly as shown in Figure 4.

Electrical Characteristics at T_A = 25°C

	Forward Voltage		Reverse Breakdown	
	V _F (Volts) [1]		V _R (Volts)	
	@ I _F = 5mA		@ $I_R = 100 \mu A$	
Part Number	Typical	Maximum	Minimum	
ASMT-CW30	2.85	3.15	5	

Notes:

1. Vf tolerance: ±0.1V

Optical Characteristics at T_A = 25°C

	Lumino	Luminous Intensity		
	I _V [1] (m	cd)		2 θ _{1/2} ^[3]
	@ 5mA		Color Chromaticity[2]	(Degrees)
Part Number	Min.	Тур.	Bin	Typical
ASMT-CW30	18.0	30.0	A1 – D2 (Refer to Figure 1)	120

Notes:

- 1. The luminous intensity I_V is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.
- 2. The chromaticity coordinates are derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- 3. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is $\frac{1}{2}$ the peak intensity.



Light Intensity (I_V) Bin Limits

	Intensity (mcc	i)
Bin ID	Minimum	Maximum
M	18.00	28.50
N	28.50	45.00
Р	45.00	71.50
Q	71.50	112.50

Tolerance: ±15%

Forward Voltage (V_F) Bin Limits

	Forward Voltage (V)		
Bin ID	Minimum	Maximum	
1	2.55	2.75	
2	2.75	2.95	
3	2.95	3.15	

Tolerance: ±0.1V

Notes:

- Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.
- 2. The Iv binning specification set-up is for lowest allowable Iv binning only. There is no upper Iv bin limits.

0.2					
0.22	A2				
0.24		B2			
0.26	A1				
0.28 0.26 0.26 0.24		B1	C2 _		
ш 0.3			C1	D2 -	
0.32					
0.34					
0.36					1

Rank	Chromaticity Coordinates					
A1	X	0.2700	0.2700	0.2500	0.2500	
Ai	Υ	0.2455	0.2780	0.2500	0.2175	
A2	X	0.2700	0.2700	0.2500	0.2500	
72	Υ	0.2455	0.2130	0.1850	0.2175	
B1	Χ	0.2700	0.2700	0.2900	0.2900	
ы	Υ	0.2455	0.2780	0.3060	0.2735	
B2	X	0.2700	0.2700	0.2900	0.2900	
D2	Υ	0.2455	0.2130	0.2410	0.2735	
C1	X	0.2900	0.3100	0.3100	0.2900	
Ci	Υ	0.3060	0.3355	0.3030	0.2735	
C2	X	0.2900	0.3100	0.3100	0.2900	
	Υ	0.2410	0.2705	0.3030	0.2735	
D1	X	0.3100	0.3100	0.3300	0.3300	
	Υ	0.3030	0.3355	0.3650	0.3325	
D2	Χ	0.3100	0.3100	0.3300	0.3300	
DZ	Υ	0.3030	0.2705	0.3000	0.3325	

Figure 1. Color bin limits (CIE 1931 Chromaticity Diagram) [Tolerance: ±0.02].

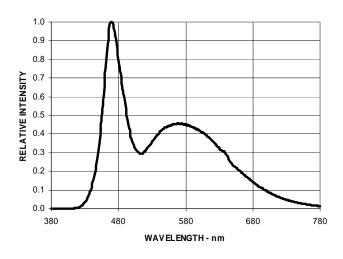


Figure 2. Relative intensity vs. wavelength.

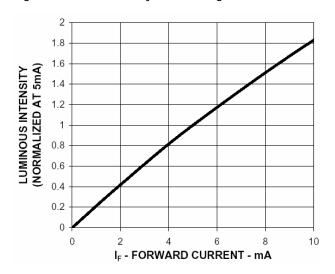
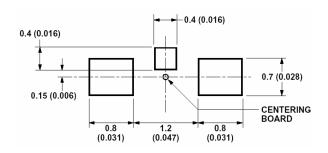


Figure 4. Luminous intensity vs. forward current.



100 WE - I 0.1 2.0 2.5 3.0 3.5 4.0 V_F - FORWARD VOLTAGE - V

Figure 3. Forward voltage vs. forward current.

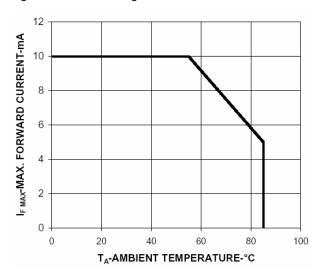


Figure 5. Maximum forward current vs. ambient temperature.

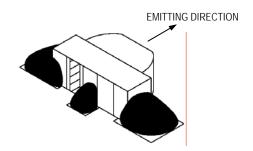


Figure 6. Recommended soldering land pattern.

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise specified.

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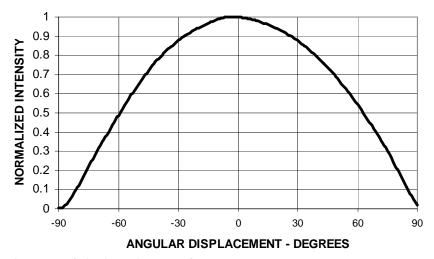
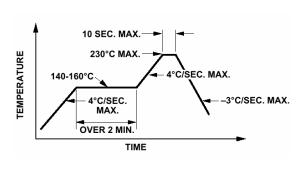


Figure 7. Relative intensity vs. angle.



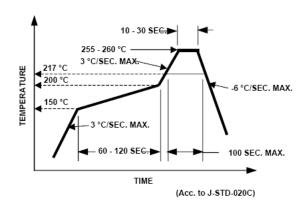


Figure 8. Recommended Reflow Soldering Profile

USER FEED DIRECTION

CATHODE SIDE

PRINTED LABEL

Figure 9. Recommended Pb-Free Reflow Soldering Profile

Figure 10. Reeling orientation.



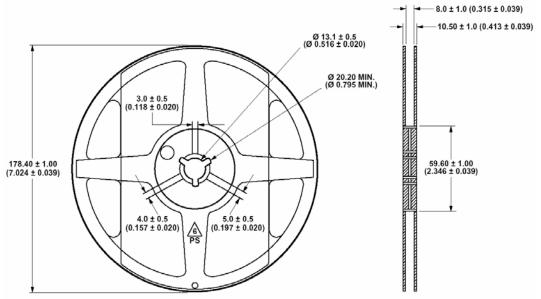


Figure 11. Reel dimensions.

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise specified.

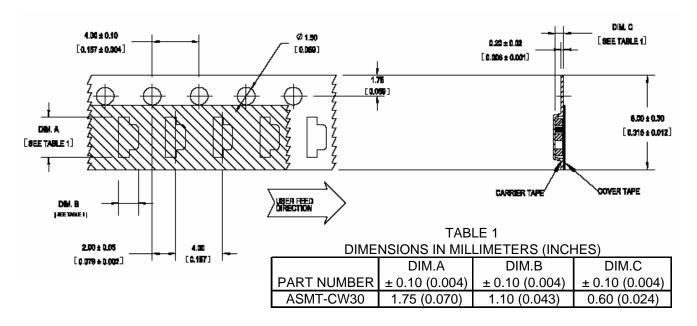


Figure 12. Tape dimensions.

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise specified.



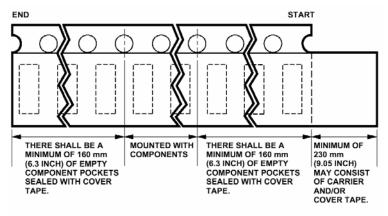


Figure 13. Tape leader and trailer dimensions.

Reflow Soldering:

For more information on reflow soldering, refer to Application Note AN-1060, *Surface Mounting SMT LED Indicator Components*.

Storage Condition:

5 to 30°C @ 60%RH max.

Baking is required before mounting, if:

- 1. Humidity Indicator Card is > 10% when read at 23 ± 5°C.
- 2. Device expose to factory conditions <30°C/60%RH more than 672 hours.

Recommended baking condition: 60 ± 5 °C for 20 hours.



Mouser Electronics

Authorized Distributor

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ASMT-CW30